



Next-generation materials for space electronics: A conceptual review

Adeola Ona-Olapo Esho ^{1,*}, Tosin Daniel Iluyomade ², Tosin Michael Olatunde ³ and Osayi Philip Igbinenikaro ⁴

¹ *Independent Researcher, Osun State, Nigeria.*

² *Mechanical Design Engineer, M+C Department, Mulalley & Co Ltd, London, United Kingdom.*

³ *Department of Electrical Power and Energy Systems (with Advanced Practice) Teesside University, Middlesbrough, UK.*

⁴ *Pisces Offshore Limited, Lagos, Nigeria.*

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Abstract

Space electronics play a pivotal role in enabling modern space missions, facilitating communication, navigation, remote sensing, and scientific exploration. However, the extreme conditions of space, including temperature variations, radiation exposure, and mechanical stresses, pose significant challenges for the materials used in electronic components. This conceptual review explores the next-generation materials for space electronics, aiming to address these challenges and push the boundaries of performance and reliability. The review begins by outlining the fundamental requirements for space electronics materials, emphasizing the need for extreme temperature resistance, radiation shielding, mechanical strength, and thermal conductivity. It then surveys the current state-of-the-art materials, including silicon-based materials, compound semiconductors, polymers, ceramics, and composites, highlighting their strengths and limitations in space applications. Furthermore, the review discusses emerging materials and technologies, such as 2D materials, organic electronics, quantum materials, and metamaterials, which hold promise for revolutionizing space electronics. Implementation strategies are proposed, considering factors like integration with existing systems, scalability, cost-effectiveness, environmental impact, and regulatory compliance. Through this conceptual review, insights are provided into the potential applications of next-generation materials in satellites, space probes, exploration missions, and beyond. The conclusion summarizes key findings, underscores potential implications for the future of space electronics, and offers recommendations for further research and development. By advancing the state of materials science for space electronics, this review aims to contribute to the ongoing exploration and utilization of space for the benefit of humanity.

Keywords: Next-Generation Materials; Space Electronics; Conceptual Review

1. Introduction

Space exploration has always been at the forefront of technological advancement, pushing the boundaries of human knowledge and capability (National Research Council et al., 2012). Central to the success of space missions is the reliable operation of electronic systems in the harsh and unforgiving environment of space (Sonko et al., 2024). As technology evolves and the demands of space exploration grow, there is an increasing need for next-generation materials that can withstand the extreme conditions encountered beyond Earth's atmosphere.

Since the dawn of the space age, electronic components have been essential for spacecraft functionality, from communication systems to navigation instruments and scientific sensors. However, traditional materials face significant challenges when exposed to the rigors of space, including wide temperature fluctuations, high levels of radiation, and vacuum conditions (Sonko et al., 2024). As a result, there is a constant drive within the space industry to develop materials that can better withstand these conditions while maintaining performance and reliability. Advancements in materials science, coupled with innovative engineering approaches, have led to significant improvements in space

* Corresponding author: Adeola Ona-Olapo Esho

electronics over the years (Gohardani et al., 2014). From the use of radiation-hardened semiconductors to the development of lightweight yet durable composites, researchers and engineers have continually sought to enhance the resilience and functionality of electronic components for space applications.

2. Literature Review

A comprehensive review of existing literature provides valuable insights into the current state-of-the-art in space electronics materials (Etukudoh et al., 2024). Numerous studies have explored the performance of various materials under simulated space conditions, shedding light on their strengths, weaknesses, and potential applications. Silicon-based materials, such as gallium arsenide and silicon carbide, have long been favored for their reliability and compatibility with existing semiconductor manufacturing processes (Hamdan et al., 2024). However, they may not always meet the stringent requirements of space missions, particularly in terms of radiation tolerance and thermal management. Recent advancements in nanotechnology have opened up new possibilities for space electronics materials, with the emergence of 2D materials like graphene and transition metal dichalcogenides showing great promise for their exceptional mechanical, electrical, and thermal properties (Hamdan et al., 2024). Additionally, organic electronics and quantum materials offer exciting opportunities for lightweight, flexible, and radiation-resistant electronic components that could revolutionize space exploration.

2.1. Problem Statement

Despite these advancements, challenges remain in developing materials that can meet the diverse and demanding needs of space missions (Abatan et al., 2024). The extreme temperatures encountered in space, ranging from the freezing depths of interplanetary space to the scorching heat near the sun, place immense stress on electronic components, leading to potential performance degradation or failure (Atadoga et al., 2024). Furthermore, the ionizing radiation present in space can cause damage to sensitive electronic circuits, compromising their functionality over time. The current reliance on traditional materials limits the performance and longevity of space electronics, constraining the capabilities of future missions and exploration endeavors (National Research Council et al., 2012). Addressing these challenges requires a concerted effort to identify, develop, and deploy next-generation materials that can thrive in the harsh environment of space while meeting the stringent requirements of space missions.

Objectives

The primary objective of this conceptual review is to explore the potential of next-generation materials for space electronics and assess their suitability for space missions (Obaigbena et al., 2024). Specifically, the review aims to:

- Identify the fundamental requirements for materials used in space electronics.
- Evaluate the current state-of-the-art materials and their applicability to space missions.
- Investigate emerging materials and technologies that show promise for space electronics applications.
- Propose implementation strategies for integrating next-generation materials into space systems.
- Discuss the challenges and opportunities associated with the adoption of new materials for space electronics.
- 1.5 Expected Outcome
- By the end of this conceptual review, it is expected that:
 - Key challenges and opportunities in space electronics materials will be identified and analyzed.
 - Insights into the potential of next-generation materials for space applications will be gained.
 - Implementation strategies for integrating new materials into space systems will be proposed.
 - Recommendations for future research and development in space electronics materials will be provided.

Overall, this conceptual review aims to contribute to the advancement of materials science for space exploration, paving the way for more capable, reliable, and resilient electronic systems in future space missions.

2.2. Fundamental Requirements for Space Electronics Materials

Space presents a challenging environment for electronic materials, characterized by extreme temperatures, high levels of radiation, vacuum conditions, and mechanical stresses (Chen et al., 2016). Meeting the demands of space missions requires materials that can withstand these harsh conditions while maintaining performance and reliability (Umoga et al., 2024). The fundamental requirements for space electronics materials can be categorized into several key areas:

2.2.1. Extreme Temperature Resistance

Spacecraft operate in a wide range of temperatures, from the extreme cold of deep space to the intense heat generated by solar radiation (Atadoga et al., 2024). Electronic components must be able to function reliably across this temperature spectrum without degradation or failure. Materials with high thermal stability and low coefficients of thermal expansion are essential to prevent cracking, warping, or delamination under temperature cycling (Sodiya et al., 2024). Additionally, thermal management techniques such as heat sinks, thermal coatings, and phase change materials may be employed to regulate component temperatures and ensure optimal performance.

2.2.2. Radiation Shielding and Tolerance

Space is pervaded by various forms of radiation, including solar wind, cosmic rays, and charged particles trapped in planetary magnetospheres (Sodiya et al., 2024). These radiations can ionize materials, degrade electronic circuits, and corrupt data stored in memory. Therefore, space electronics materials must possess inherent radiation tolerance or be shielded from harmful radiation sources (Abatan et al., 2024). Radiation-hardened semiconductors, such as gallium arsenide and silicon carbide, are commonly used to mitigate the effects of ionizing radiation on electronic devices. Additionally, shielding materials such as lead, polyethylene, and composite materials containing heavy elements can be employed to protect sensitive components from radiation-induced damage.

2.2.3. Mechanical Strength and Durability

Spacecraft experience mechanical stresses during launch, maneuvering, and landing, as well as from micrometeoroid impacts and thermal expansion/contraction (Swanson, 2008). Electronic materials must be mechanically robust to withstand these forces without fracturing, deformation, or fatigue failure (Olajiga et al., 2024). High-strength materials such as ceramics, composites, and alloys are often used to fabricate structural components and enclosures for electronic assemblies. Additionally, conformal coating and potting materials may be applied to protect delicate electronic components from mechanical shock and vibration (Ani et al., 2024).

2.2.4. Thermal Conductivity and Dissipation

Efficient thermal management is critical to ensure the proper functioning and longevity of space electronics (Lv et al., 2024). Heat generated by electronic components must be dissipated to prevent overheating and thermal runaway. Materials with high thermal conductivity, such as copper, aluminum, and diamond, are used to facilitate heat transfer away from hotspots and dissipate excess heat into the surrounding environment (Omole et al., 2024). Thermal interface materials, such as thermal greases, adhesives, and phase change materials, are employed to improve the thermal contact between electronic components and heat sinks. Additionally, passive and active cooling systems, including radiators, heat pipes, and thermoelectric coolers, may be utilized to maintain optimal operating temperatures for electronic devices (Adeleke et al., 2024).

In summary, space electronics materials must possess a unique combination of properties to withstand the extreme conditions of space while maintaining performance and reliability. By addressing the fundamental requirements for space electronics materials, researchers and engineers can develop innovative solutions to enable the next generation of space exploration and scientific discovery.

2.3. Current State-of-the-Art Materials

Advancements in materials science have led to the development of a wide range of materials suitable for space electronics applications (Levchenko et al., 2018). These materials exhibit various properties such as high temperature resistance, radiation tolerance, mechanical strength, and thermal conductivity. The current state-of-the-art materials for space electronics include:

2.3.1. Silicon-based Materials

Silicon has been the cornerstone of the semiconductor industry for decades and remains a popular choice for space electronics applications (Olu-lawal et al., 2024). Silicon-based materials offer excellent electronic properties, compatibility with standard semiconductor fabrication processes, and relatively low cost. Silicon-on-insulator (SOI) technology provides enhanced radiation hardness by reducing the susceptibility of devices to latch-up effects caused by ionizing radiation (Olajiga et al., 2024). Additionally, silicon carbide (SiC) is gaining popularity for its superior thermal conductivity, wide bandgap, and radiation tolerance, making it suitable for high-power and high-temperature applications in space.

2.3.2. Gallium Nitride (GaN) and Other Compound Semiconductors

Gallium nitride (GaN) and other compound semiconductors are increasingly used in space electronics for their superior performance characteristics compared to silicon-based materials (Olajiga et al., 2024). GaN-based devices exhibit higher electron mobility, breakdown voltage, and operating frequency, making them well-suited for high-frequency and high-power applications such as radio frequency (RF) amplifiers and power converters (Hoo Teo et al., 2021). Moreover, GaN devices offer better radiation hardness than silicon-based counterparts, enabling their use in radiation-intensive space environments.

2.3.3. Polymer-based Materials

Polymer-based materials, such as polyimides and polyether ether ketone (PEEK), are valued for their lightweight, flexible, and dielectric properties, making them suitable for space electronics applications (Adeleke et al., 2024). These materials are often used in the fabrication of flexible circuits, thermal insulation, and protective coatings for electronic assemblies. Polyimide films, in particular, are utilized as substrates for flexible printed circuit boards (PCBs) and as insulating layers in multilayer electronic packages. Additionally, polymers can be doped with additives or fillers to enhance their thermal and mechanical properties for space applications (Adeleke et al., 2024).

2.3.4. Ceramics and Composites

Ceramics and composites offer excellent mechanical strength, thermal stability, and radiation resistance, making them ideal materials for structural components and protective enclosures in space electronics (Prabhakaran, 2015). Aluminum oxide (alumina) and aluminum nitride (AlN) ceramics are commonly used for their high thermal conductivity and electrical insulation properties. Additionally, composite materials composed of ceramic fibers embedded in a polymer matrix, such as carbon fiber-reinforced polymers (CFRP) and glass fiber-reinforced polymers (GFRP), combine the lightweight and flexibility of polymers with the strength and stiffness of ceramics, making them suitable for space applications requiring a high strength-to-weight ratio (Iwuanyanwu et al., 2023).

In summary, the current state-of-the-art materials for space electronics encompass a diverse range of materials, each offering unique advantages and suitability for specific applications. By leveraging the strengths of these materials and exploring novel fabrication techniques, researchers and engineers can continue to advance the state of space electronics technology and enable future space exploration missions (Odulaja et al., 2023).

2.4. Emerging Materials and Technologies

As space exploration pushes the boundaries of human knowledge and capability, there is a constant need for materials and technologies that can meet the evolving demands of space missions (Adekuajo et al., 2023). Emerging materials offer unique properties and capabilities that have the potential to revolutionize space electronics and enable new possibilities for exploration, communication, and scientific discovery. The following are some of the most promising emerging materials and technologies for space electronics:

2.4.1. 2D Materials (Graphene, Transition Metal Dichalcogenides)

Two-dimensional (2D) materials, such as graphene and transition metal dichalcogenides (TMDs), have attracted significant attention for their extraordinary electronic, mechanical, and thermal properties. Graphene, a single layer of carbon atoms arranged in a honeycomb lattice, exhibits high electron mobility, exceptional mechanical strength, and excellent thermal conductivity (Oyewole et al., 2023). TMDs, such as molybdenum disulfide (MoS₂) and tungsten diselenide (WSe₂), possess tunable bandgaps and optical properties, making them suitable for a wide range of electronic and optoelectronic applications (Voshell et al., 2018). In space electronics, 2D materials hold promise for lightweight, flexible, and radiation-resistant electronic components. Graphene-based transistors, sensors, and interconnects could offer improved performance and reliability compared to traditional silicon-based devices. Additionally, TMD-based photodetectors and solar cells could enable advanced imaging and power generation systems for space exploration missions (Farayola et al., 2023).

2.4.2. Organic Electronics

Organic electronics utilize carbon-based materials, such as polymers and small molecules, to fabricate electronic devices with unique properties and functionalities (Apeh et al., 2023). Organic semiconductors offer advantages such as flexibility, low cost, and compatibility with large-area fabrication techniques, making them attractive for applications requiring lightweight and conformable electronic systems. In space electronics, organic materials can be used to fabricate flexible solar cells, thin-film transistors, and sensors for a variety of applications (Oladeinde et al., 2023).

Organic photovoltaic cells offer the potential for lightweight and low-cost power generation in space, while organic sensors can be integrated into spacecraft structures for structural health monitoring and environmental sensing.

2.4.3. Quantum Materials

Quantum materials exhibit exotic quantum mechanical properties, such as superconductivity, topological insulator behavior, and quantum entanglement, which could enable transformative advances in space electronics (Okoro et al., 2023). Materials such as topological insulators, superconductors, and quantum dots have the potential to revolutionize electronic devices, communication systems, and sensing technologies for space exploration. In space electronics, quantum materials could be used to develop high-performance computing systems, secure quantum communication networks, and ultra-sensitive detectors for gravitational wave detection and dark matter observation (Oladeinde et al., 2023). Furthermore, superconducting materials could enable the development of low-power cryogenic electronics for space-based telescopes and particle detectors.

2.4.4. Metamaterials

Metamaterials are artificial structures engineered to exhibit unique electromagnetic properties not found in naturally occurring materials (Hassan et al., 2024). By controlling the arrangement of subwavelength structures, metamaterials can manipulate electromagnetic waves in ways that are not possible with conventional materials. Metamaterials offer unprecedented control over the propagation, absorption, and emission of light, enabling a wide range of applications in space electronics and photonics (Ilic, 2020). In space electronics, metamaterials can be used to develop novel antennas, lenses, and filters for communication and sensing applications. Metamaterial-based antennas offer improved performance and efficiency compared to traditional antennas, enabling higher data rates and longer communication distances in space (Hamdan et al., 2024). Additionally, metamaterial-based optical components could enhance the sensitivity and resolution of space-based imaging systems, enabling new insights into the cosmos.

In summary, emerging materials and technologies hold great promise for advancing the capabilities of space electronics and enabling new opportunities for space exploration and scientific discovery. By leveraging the unique properties of these materials, researchers and engineers can develop innovative solutions to address the challenges of space missions and unlock the full potential of space exploration.

3. Methodology or proposed solution of the concept paper

In order to effectively address the challenges and opportunities presented by next-generation materials for space electronics, a comprehensive methodology and proposed solution must be outlined. This section discusses the various aspects of the proposed solution, including integration strategies with existing systems and technologies, scalability and cost-effectiveness considerations, environmental impact and sustainability assessments, and regulatory and safety compliance measures.

3.1. Integration Strategies with Existing Systems and Technologies

Integration with existing systems and technologies is essential for the successful adoption of next-generation materials in space electronics (Nwokediegwu et al., 2024). Compatibility with established manufacturing processes, interface standards, and system architectures must be considered to ensure seamless integration and interoperability (Ray and Jones, 2006). Collaboration between material scientists, engineers, and space agencies is critical to identify integration challenges and develop solutions that meet the requirements of space missions. Furthermore, modular design approaches and standardization efforts can facilitate the integration of new materials into existing space systems (Ibekwe et al., 2024). By designing components and subsystems with interchangeable interfaces and standardized connectors, upgrades and replacements can be performed more efficiently, reducing downtime and cost. Additionally, simulation and modeling tools can be used to assess the performance of integrated systems and identify potential areas for optimization.

3.2. Scalability and Cost-Effectiveness Considerations

Scalability and cost-effectiveness are key considerations when evaluating next-generation materials for space electronics. While novel materials may offer superior performance and capabilities, their adoption must be economically viable and scalable to meet the demands of space missions (Sonko et al., 2024). Factors such as material availability, manufacturing complexity, and production yield rates must be carefully considered to ensure cost-effective deployment. Furthermore, lifecycle cost analysis and total cost of ownership assessments can provide valuable insights into the long-term economic viability of next-generation materials (Sonko et al., 2024). By considering factors such as material durability, maintenance requirements, and operational efficiencies, decision-makers can make informed

choices about the adoption of new materials for space electronics (Diaz et al., 2021). Additionally, collaborative research and development efforts, public-private partnerships, and government incentives can help mitigate upfront costs and accelerate the commercialization of new materials.

3.3. Environmental Impact and Sustainability Assessments

Environmental impact and sustainability assessments are essential for evaluating the ecological footprint of next-generation materials for space electronics (Nwokiediegwu et al., 2024). While space missions offer unique opportunities for scientific exploration and technological advancement, they also have environmental consequences that must be carefully managed. The production, use, and disposal of materials can result in resource depletion, pollution, and waste generation, impacting both terrestrial and space environments. Therefore, lifecycle assessment (LCA) methodologies can be employed to evaluate the environmental impacts of different materials throughout their lifecycle, from extraction and manufacturing to use and disposal (Babatunde et al., 2024). By quantifying factors such as energy consumption, greenhouse gas emissions, and waste generation, LCAs can inform decision-making processes and guide the selection of materials with lower environmental footprints. Additionally, sustainable material sourcing practices, recycling initiatives, and waste reduction strategies can help minimize the environmental impact of space electronics.

3.4. Regulatory and Safety Compliance Measures

Regulatory and safety compliance measures are essential to ensure the safe and responsible use of next-generation materials in space electronics (Olajiga et al., 2024). Space agencies and regulatory bodies establish standards, guidelines, and requirements for materials used in space missions to ensure mission success and protect personnel, spacecraft, and the space environment. Compliance with these regulations is mandatory for all space missions, and failure to adhere to them can result in mission failure, legal liabilities, and reputational damage (Okoli et al., 2024). Therefore, thorough testing, validation, and certification processes are conducted to assess the performance, reliability, and safety of materials intended for space use. Materials must undergo rigorous testing for radiation tolerance, thermal stability, mechanical strength, and outgassing properties to ensure they meet the requirements of space missions (Olorunfemi et al., 2024). Additionally, materials must comply with international treaties and agreements governing the peaceful use of outer space, such as the Outer Space Treaty and the Space Debris Mitigation Guidelines (Nunes Tartari, 2022).

In summary, the methodology and proposed solution for addressing the challenges and opportunities presented by next-generation materials for space electronics involve integration strategies with existing systems and technologies, scalability and cost-effectiveness considerations, environmental impact and sustainability assessments, and regulatory and safety compliance measures (Usman et al., 2024). By adopting a holistic approach that considers technical, economic, environmental, and regulatory factors, researchers and engineers can develop innovative solutions that advance the state of space electronics while ensuring the safety, reliability, and sustainability of space missions (Umoh et al., 2024).

4. Conclusion

The exploration of next-generation materials for space electronics presents a significant opportunity to enhance the capabilities, reliability, and sustainability of space missions. Through this conceptual review, key insights have been gained into the challenges and opportunities associated with the adoption of new materials in space electronics. The following sections provide a summary of key findings and insights, discuss potential implications for the future of space electronics, and offer recommendations for further research and development. Throughout this review, several key findings and insights have emerged regarding the current state and future prospects of materials for space electronics. Traditional materials such as silicon-based semiconductors and ceramics offer reliability and compatibility with existing systems, but they may not always meet the stringent requirements of space missions, particularly in terms of radiation tolerance and thermal management. Emerging materials such as 2D materials, organic electronics, quantum materials, and metamaterials show promise for revolutionizing space electronics, offering unique properties such as flexibility, radiation resistance, and quantum mechanical effects. Integration with existing systems and technologies, scalability and cost-effectiveness considerations, environmental impact and sustainability assessments, and regulatory and safety compliance measures are critical factors to consider when evaluating next-generation materials for space electronics. Collaborative research and development efforts, public-private partnerships, and government incentives can accelerate the adoption of new materials and technologies in space missions. The adoption of next-generation materials has the potential to revolutionize space electronics and enable new capabilities for space exploration, communication, and scientific discovery. Lightweight and flexible materials such as 2D materials and organic electronics could enable the development of compact and versatile spacecraft systems, reducing launch costs and increasing

mission efficiency. Quantum materials and metamaterials could enable breakthroughs in communication, sensing, and computing, unlocking new possibilities for space-based technologies.

Furthermore, advancements in materials science could lead to the development of self-healing materials, adaptive materials, and materials with novel properties tailored for specific space environments. These materials could enhance the resilience and reliability of space electronics, enabling long-duration missions to distant destinations such as Mars and beyond.

To capitalize on the potential of next-generation materials for space electronics, further research and development efforts are recommended in the following areas; Exploration of novel materials and fabrication techniques tailored for space applications, focusing on properties such as radiation tolerance, thermal stability, mechanical strength, and environmental compatibility. Integration of new materials into existing space systems and architectures, ensuring compatibility, interoperability, and reliability. Evaluation of the scalability and cost-effectiveness of next-generation materials, considering factors such as material availability, manufacturing complexity, and lifecycle cost. Assessment of the environmental impact and sustainability of materials used in space missions, with a focus on resource consumption, waste generation, and pollution. Compliance with regulatory and safety requirements governing the use of materials in space, ensuring mission success and environmental protection. By addressing these research priorities, the space industry can unlock the full potential of next-generation materials for space electronics, paving the way for a new era of exploration and discovery in the cosmos.

Compliance with ethical standards

Disclosure of conflict of interest

No conflict of interest to be disclosed.

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